**ESD High Temp Masking Tape**

Used in applications masking PCB gold features for wave soldering

- Waterproof
- Does not charge significantly but has minimal charge retention
- 7 mil (0.007" or 0.18 mm) total thickness
- Adhesive surface 1.2 x 10^11 ohms
- Film resistance < 1 x 10^11 ohms tested per ANSI/ESD S11.11 at 50% RH
- Max Temp 135°C (275°F) 45 minutes max
- Non-toxic
- pH neutral
- Non-corrosive
- Tensile: 22 lbs./in.
- Adhesion to Steel: 35 oz./inch^2
- Elongation: 8%
- Temperature Range: -32°F to +275°F
- Adhesive Mass: Natural Rubber
- Adhesive: Non-Staining
- Excellent Conformability

**Note:** Waterproof release coating does generate static charges during unrolling. We recommend slow unwinding, utilizing an Ionizer to neutralize charge.

**Width - See Table Below**

<table>
<thead>
<tr>
<th>Tape</th>
<th>0.5&quot;</th>
<th>.75&quot;</th>
<th>1&quot;</th>
<th>Core</th>
<th>Length</th>
</tr>
</thead>
<tbody>
<tr>
<td>ESD High Temp Masking</td>
<td>81260</td>
<td>81261</td>
<td>81262</td>
<td>3&quot;</td>
<td>60 yds</td>
</tr>
</tbody>
</table>

*Width tolerance ±1/32”*

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WESCORP® ESD HIGH TEMP MASKING TAPE, PAPER CORE

**WESCO**

DESIGN NUMBER: 81260

DRAWING NUMBER: 81260

DATE: January 2018